0/-10-02

Transmitted herewith for filing is the Patent Application of:

Grentor: Dun-Nian Yaung, Shou-Gwo wuu, Chien-Hsien Tseng

GRID METAL DESIGN FOR LARGE DENSITY CMOS IMAGE SENSOR

Encl	.osed	are:

X = 3 sheets	of	drawing(s)	-	formal
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An assignment of the invention to Taiwan Semiconductor Manufacturing Company

An associate power of attorney Applicant claims small entity status

Request & Certification under 35 USC 122(b)(2)(b)(i)

	X Request & Certification under 35 USC 122(b)(2)(b)(i)							
The filing fee has been calculated as shown below:								
w.		(Col. 1) (Col. 2)		OTHER THAN A SMALL ENTITY				
	FOR:	NO. FILED	NO. EXTRA	RATE	FEE			
	BASIC FEE				\$ 740.			
	TOTAL CLAIMS	<b>40</b> -20=	20	x 18 =	\$ 360.			
	INDEP CLAIMS	6 -3=	3	x 84 =	\$ 252.			
1.5		J 232.						
	MULTIPLE							
SUB TOTAL				\$ 1,352.				
ASSIGNMENT					\$40.			
TOTAL					\$ 1,392.			

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- 1/8/02

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I hereby request that the attached application not be published under 35 U.S.C. 122(b).

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This request must be signed in compliance with 37 CFR 1.33(b) and submitted with the application upon filing.

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